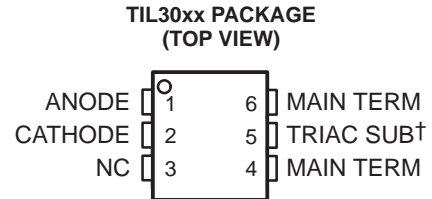


- 250-V Phototriac Driver Output
- Gallium-Arsenide-Diode Infrared Source and Optically-Coupled Silicon Triac Driver (Bilateral Switch)
- UL Recognized . . . File Number E65085
- High Isolation . . . 3535 V peak
- Output Driver Designed for 115 Vac
- Standard 6-Pin Plastic DIP

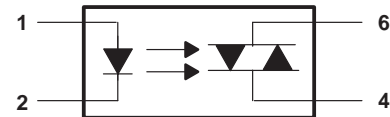


† Do not connect this terminal  
NC – No internal connection

### typical 115 Vac(rms) applications

- Solenoid/Valve Controls
- Lamp Ballasts
- Interfacing Microprocessors to 115-Vac Peripherals
- Motor Controls
- Incandescent Lamp Dimmers

### logic diagram



### description

Each device consists of a gallium-arsenide infrared-emitting diode optically coupled to a silicon phototriac mounted on a 6-pin lead frame encapsulated within an electrically nonconductive plastic compound. The case withstands soldering temperature with no deformation. Device performance characteristics remain stable when operated in high-humidity conditions.

### absolute maximum ratings at 25°C free-air (unless otherwise noted)†

Input-to-output peak voltage, 5 s maximum duration, 60 Hz (see Note 1)	3.535 kV
Input diode reverse voltage	3 V
Input diode forward current, continuous	50 mA
Output repetitive peak off-state voltage	250 V
Output on-state current, total rms value (50-60 Hz, full sine wave): $T_A = 25^\circ$	100 mA
$T_A = 70^\circ$	50 mA
Output driver nonrepetitive peak on-state current ( $t_W = 10$ ms, duty cycle = 10%, see Figure 7)	1.2 A
Continuous power dissipation at (or below) 25°C free-air temperature:	
Infrared-emitting diode (see Note 2)	100 mW
Phototriac (see Note 3)	300 mW
Total device (see Note 4)	330 mW
Operating junction temperature range, $T_J$	-40°C to 100°C
Storage temperature range, $T_{stg}$	-40°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. Input-to-output peak voltage is the internal device dielectric breakdown rating.
  2. Derate linearly to 100°C free-air temperature at the rate of 1.33 mW/°C.
  3. Derate linearly to 100°C free-air temperature at the rate of 4 mW/°C.
  4. Derate linearly to 100°C free-air temperature at the rate of 4.4 mW/°C.

# TIL3009, TIL3010, TIL3011, TIL3012 OPTOCOUPLEDERS/OPTOISOLATORS

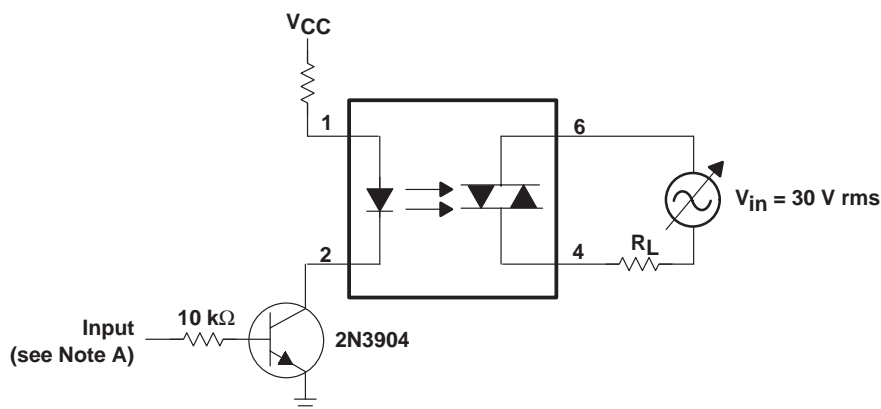
SOES027A – DECEMBER 1987 – REVISED APRIL 1998

## electrical characteristics 25°C free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_R$	Static reverse current	$V_R = 3\text{ V}$		0.05	100	$\mu\text{A}$
$V_F$	Static forward voltage	$I_F = 10\text{ mA}$		1.2	1.5	V
$I_{DRM}$	Repetitive off-state current, either direction	$V_{DRM} = 250\text{ V}$ , See Note 5		10	100	nA
dv/dt	Critical rate of rise of off-state voltage	See Figure 1		12		V/ $\mu\text{s}$
dv/dt(c)	Critical rate of rise of commutating voltage	$I_O = 15\text{ mA}$ , See Figure 1		0.15		V/ $\mu\text{s}$
$I_{FT}$	Input trigger current either direction	Output supply voltage = 3 V	TIL3009	15	30	mA
			TIL3010	8	15	
			TIL3011	5	10	
			TIL3012		5	
$V_{TM}$	Peak on-state voltage, either direction	$I_{TM} = 100\text{ mA}$		1.8	3	V
$I_H$	Holding current, either direction			100		$\mu\text{A}$

NOTE 5: Test voltage must be applied within dv/dt rating.

## PARAMETER MEASUREMENT INFORMATION



NOTE A. The critical rate of rise of off-state voltage, dv/dt, is measured with the input set at 0 volts. The frequency of  $V_{in}$  is increased until the phototriac turns on. This frequency is then used to calculate the dv/dt according to the following formula:

$$dv/dt = 2\sqrt{2}\pi f V_{in}$$

The critical rate of rise of commutating voltage, dv/dt(c), is measured by applying occasional 5-volt pulses to the input and increasing the frequency of  $V_{in}$  until the phototriac remains on (latches) after the input pulse has ceased. With no further input pulses, the frequency of  $V_{in}$  is then gradually decreased until the phototriac turns off. The frequency at which turn-off occurs can then be used to calculate the dv/dt(c) according to the formula shown above.

Figure 1. Critical Rate of Rise Test Circuit

TYPICAL CHARACTERISTICS

EMITTING DIODE TRIGGER CURRENT (NORMALIZED)  
vs  
FREE-AIR TEMPERATURE

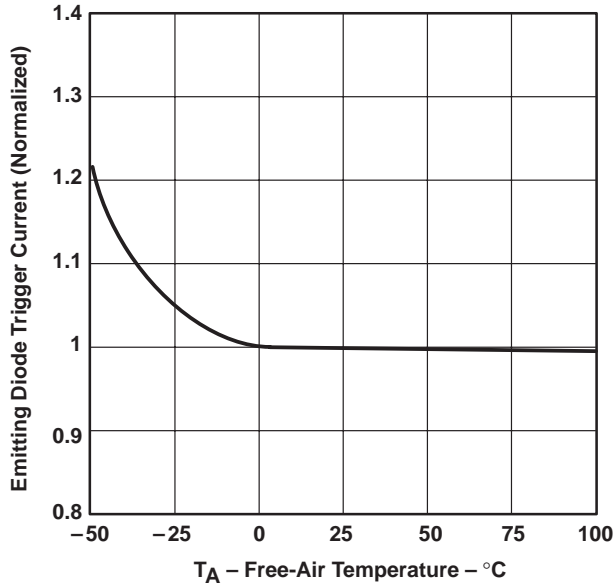


Figure 2

ON-STATE CHARACTERISTICS

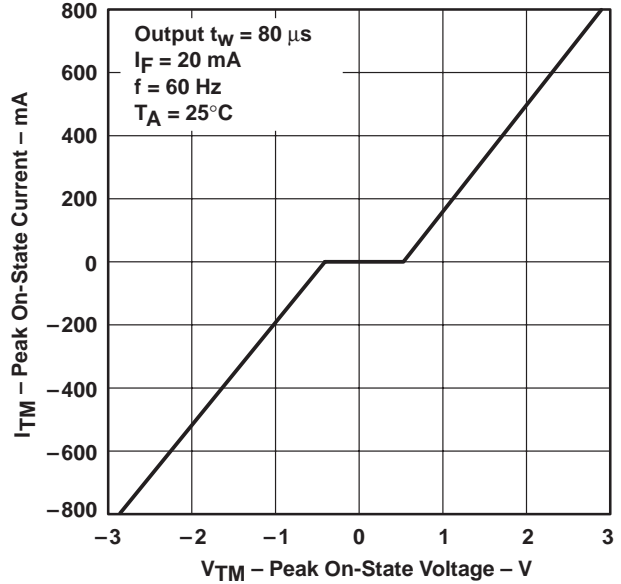


Figure 3

CRITICAL RATE OF RISE OF OUTPUT VOLTAGE  
OFF-STATE dv/dt AND COMMUTATING dv/dt(c)  
vs  
LOAD RESISTANCE

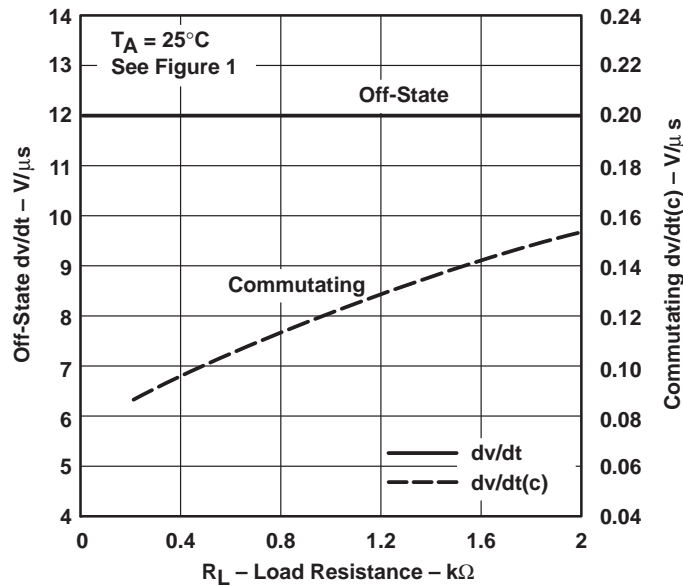


Figure 4

TYPICAL CHARACTERISTICS

OFF-STATE  $dv/dt$  AND COMMUTATING  $dv/dt$   
vs  
FREE-AIR TEMPERATURE

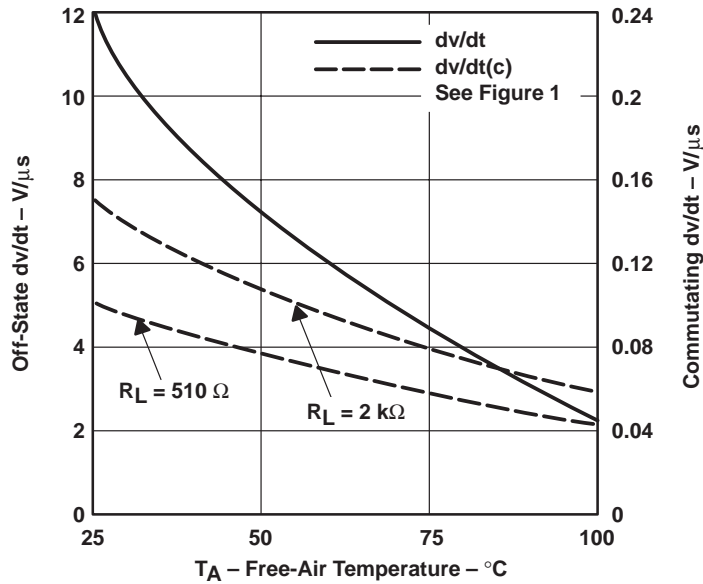


Figure 5

RMS APPLIED VOLTAGE  
(FOR  $dv/dt(c) = 0.15 V/\mu s$ )  
vs  
FREQUENCY

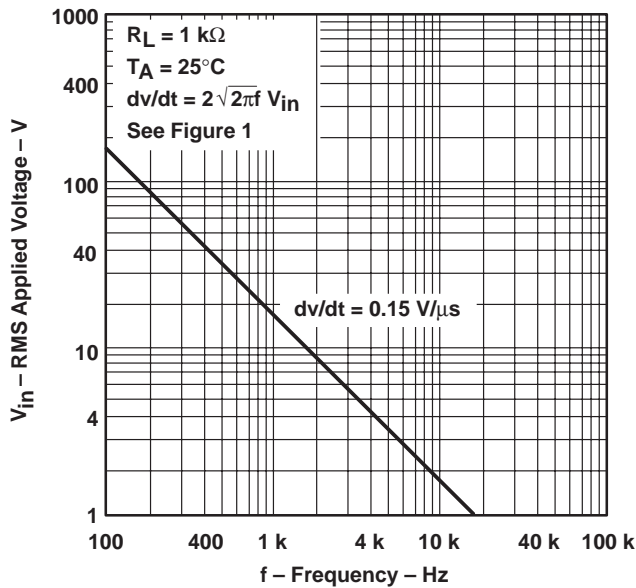


Figure 6

NONREPETITIVE PEAK ON-STATE CURRENT  
vs  
PULSE DURATION

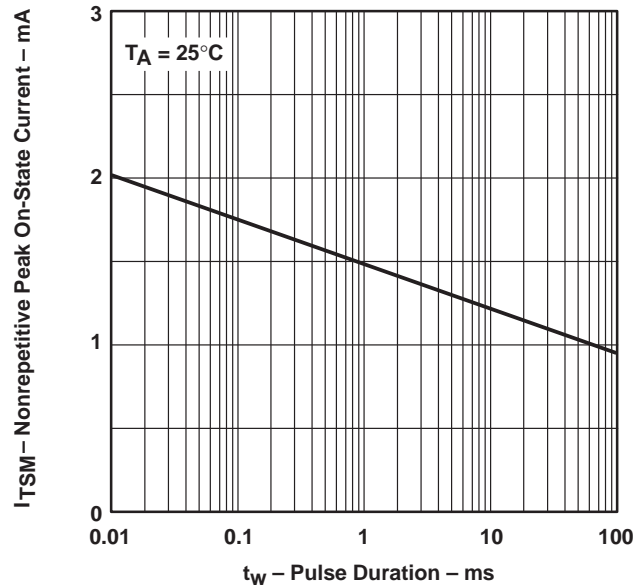


Figure 7

APPLICATION INFORMATION

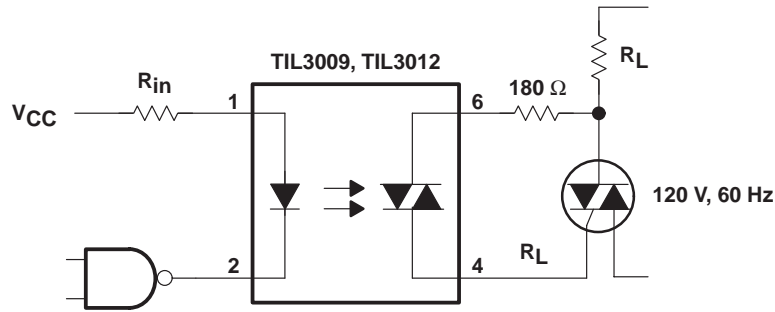


Figure 8. Resistive Load

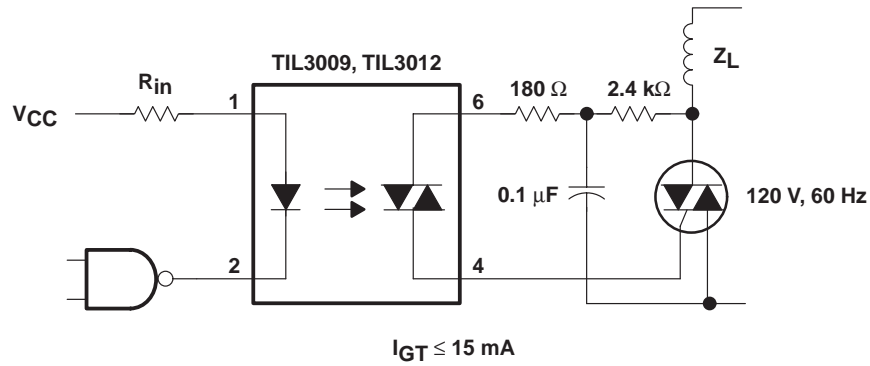


Figure 9. Inductive Load With Sensitive-Gate Triac

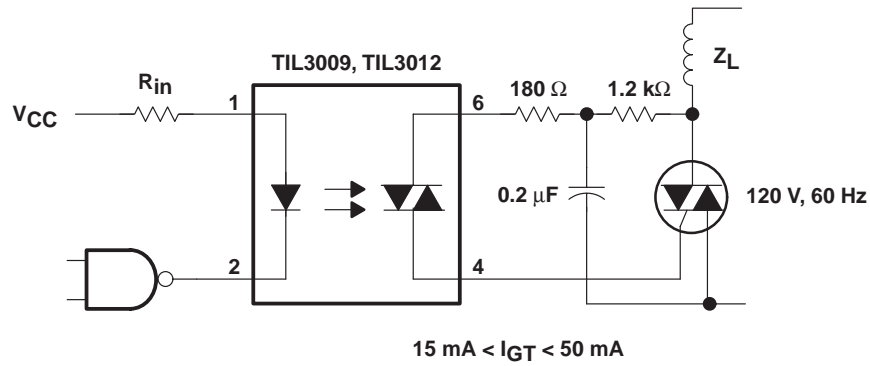
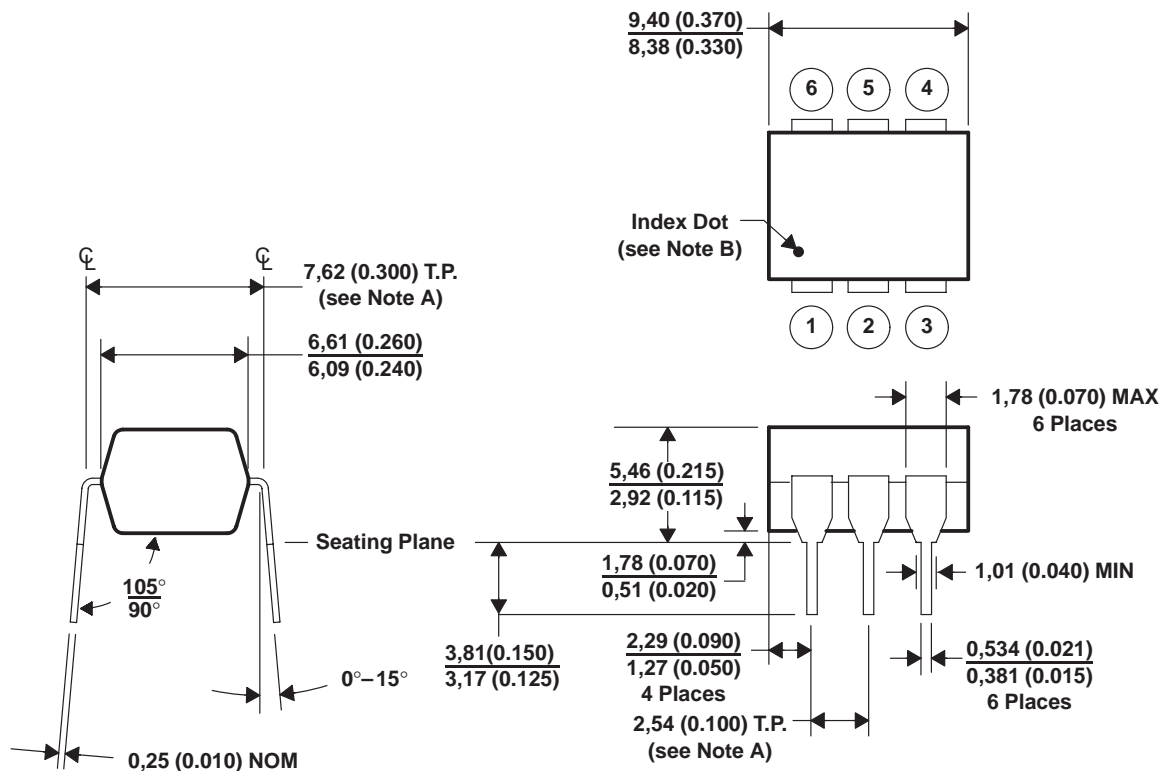


Figure 10. Inductive Load With Nonsensitive-Gate Triac

MECHANICAL INFORMATION



- NOTES: A. Leads are within 0,13 mm (0.005 inch) radius of true position (T.P.) with maximum material condition and unit installed.  
 B. Pin 1 identified by index dot.  
 C. The dimensions given fall within JEDEC MO-001 AM dimensions.  
 D. All linear dimensions are given in millimeters and parenthetically given in inches.

Figure 11. Packaging Specifications

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